P-Channel Enhancement Mode Power MOSFET

Description

The G700P06LLA uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

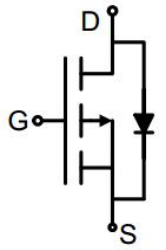
AEC-Q101 Qualified

General Features

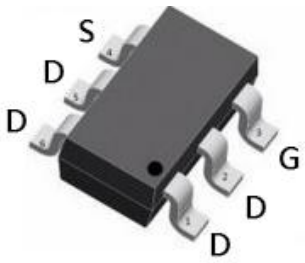
- V_{DS} -60V
- I_D (at V_{GS} = -10V) -5.5A
- $R_{DS(ON)}$ (at V_{GS} = -10V) < 75mΩ
- $R_{DS(ON)}$ (at V_{GS} = -4.5V) < 90mΩ
- 100% Avalanche Tested
- RoHS Compliant

Application

- Power switch
- DC/DC converters



Schematic diagram



SOT-23-6L

Ordering Information

Device	Package	Marking	Packaging
G700P06LLA	SOT-23-6	G700P06	3000pcs/Reel

Absolute Maximum Ratings T_C = 25ºC, unless otherwise noted

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	-60	V
Continuous Drain Current	T_C = 25ºC	I_D	-5.5	A
	T_C = 100ºC		-3.9	
Pulsed Drain Current	(note1)	I_{DM}	-22	A
Gate-Source Voltage		V_{GS}	±20	V
Power Dissipation		P_D	3.72	W
Single pulse avalanche energy	（note2）	E_{AS}	25	mJ
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 To 175	ºC

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	40.3	ºC/W

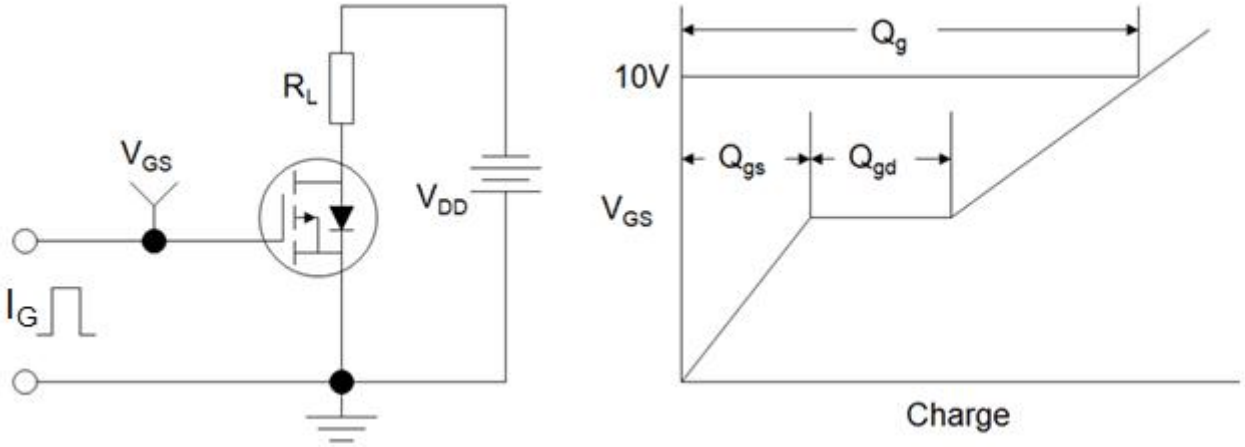
Specifications T_J = 25ºC, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = -250μA	-60	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = -60V, V_{GS} = 0V	--	--	-1	μA
Gate-Source Leakage	I_{GSS}	V_{GS} = ±20V	--	--	±100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250μA	-1.0	-1.8	-3.0	V
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS} = -10V, I_D = -3.2A	--	61	75	mΩ
		V_{GS} = -4.5V, I_D = -3.2A	--	74	90	
Forward Transconductance	g_{FS}	V_{DS} = -5V,I_D = -3.2A	--	9	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = -30V, f = 1.0MHz	--	1456	--	pF
Output Capacitance	C_{oss}		--	71	--	
Reverse Transfer Capacitance	C_{rss}		--	64	--	
Total Gate Charge	Q_g	V_{DD} = -30V, I_D = -3A, V_{GS} = -10V	--	15.8	--	nC
Gate-Source Charge	Q_{gs}		--	2.7	--	
Gate-Drain Charge	Q_{gd}		--	3.5	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = -30V, I_D = -3A, R_G = 3Ω	--	8	--	ns
Turn-on Rise Time	t_r		--	5	--	
Turn-off Delay Time	$t_{d(off)}$		--	32	--	
Turn-off Fall Time	t_f		--	8	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	T_C = 25ºC	--	--	-5.5	A
Body Diode Voltage	V_{SD}	T_J = 25ºC, I_{SD} = -30A, V_{GS} = 0V	--	--	-1.2	V
Reverse Recovery Charge	Q_{rr}	I_F = -3A, V_{GS} = 0V di/dt=-100A/us	--	32	--	nC
Reverse Recovery Time	T_{rr}		--	27	--	ns

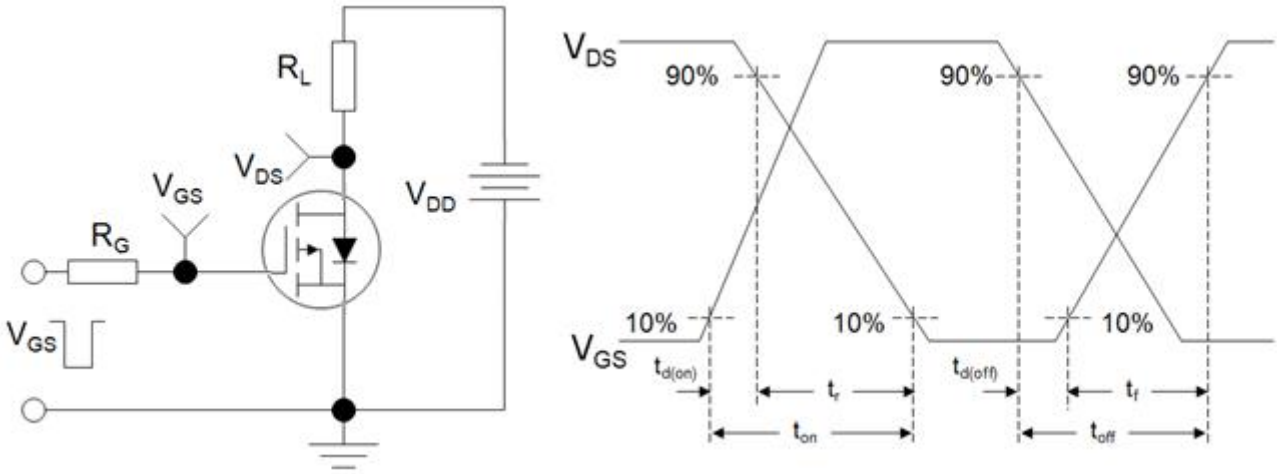
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. EAS condition : Tj=25℃ ,VDD=-50V,VGS=-10V,L=0.5mH,Rg=25Ω
3. Identical low side and high side switch with identical R_G

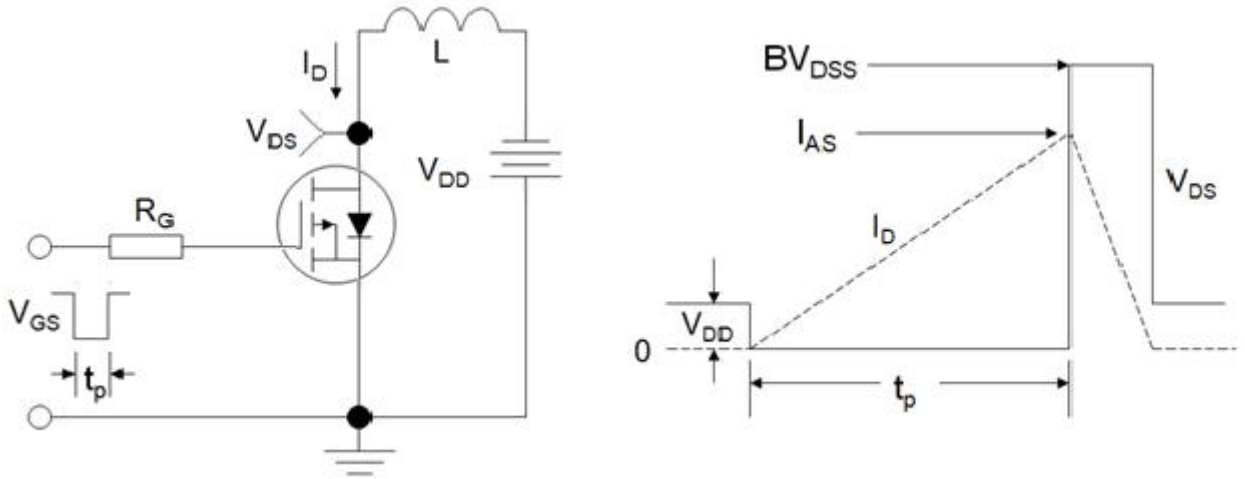
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 1. Output Characteristics

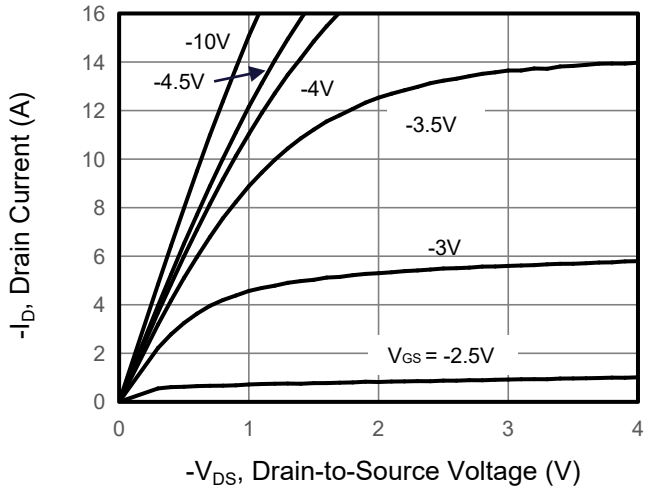


Figure 2. Transfer Characteristics

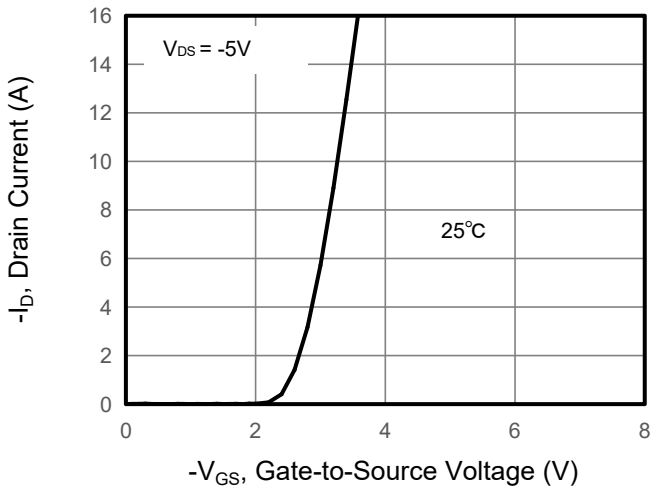


Figure 3.Drain Source On Resistance

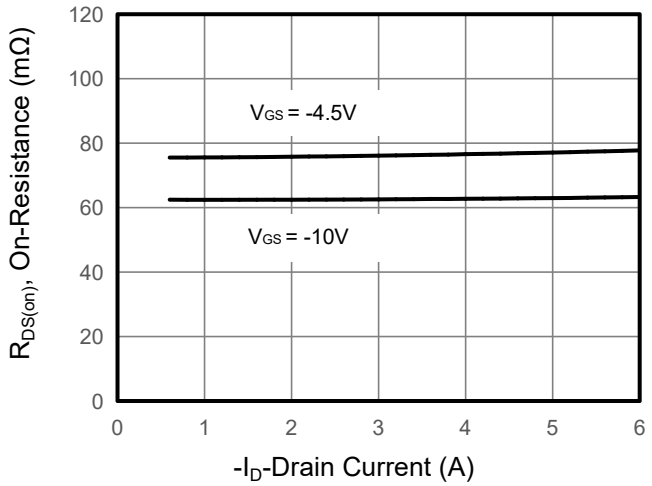


Figure 4. Gate Charge

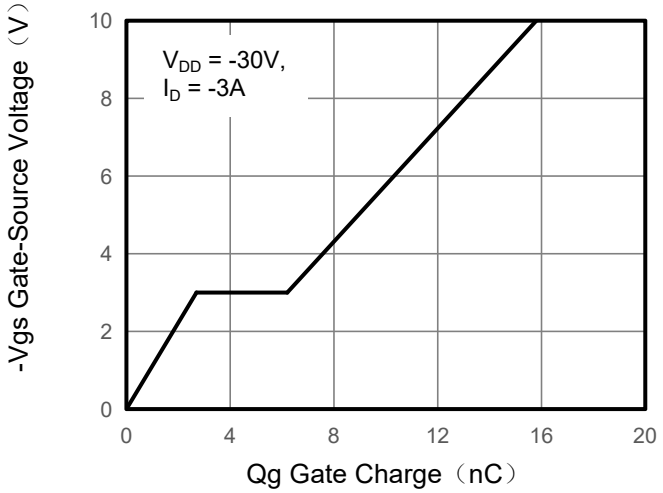


Figure 5. Capacitance

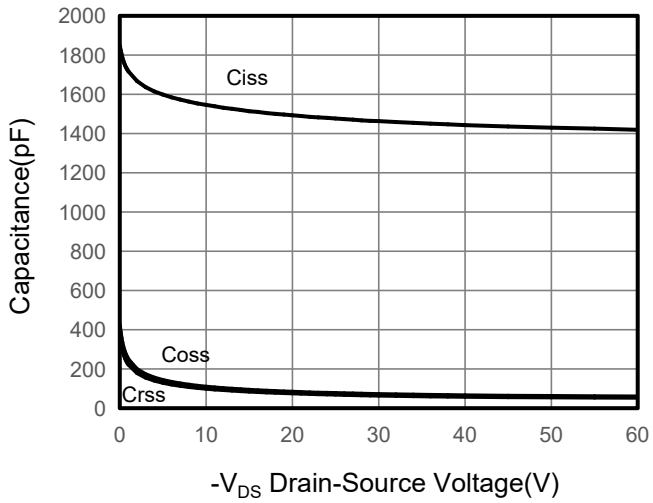
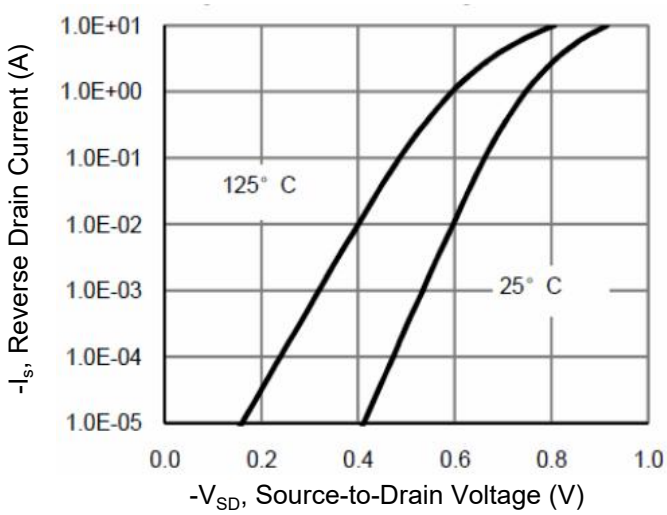


Figure 6. Source-Drain Diode Forward



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 7. Drain-Source On-Resistance

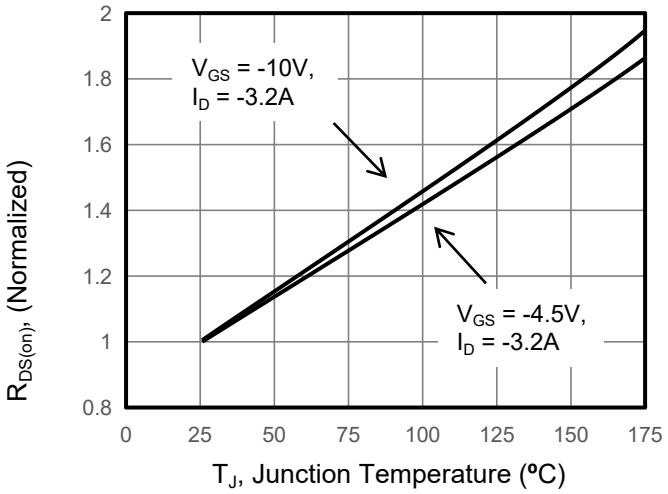


Figure 8. Safe Operation Area

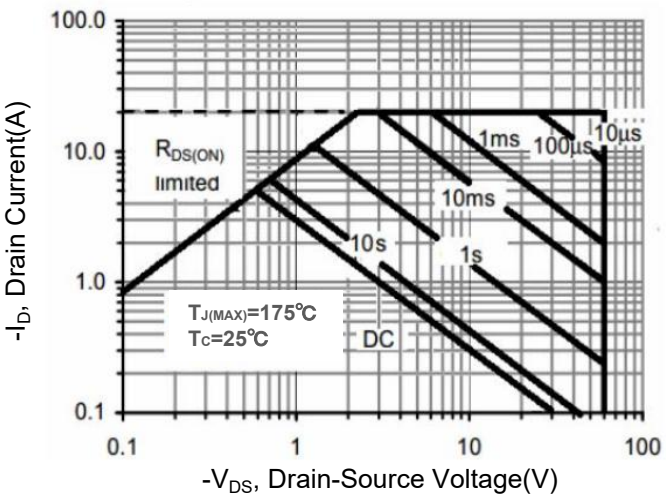


Figure 9. Maximum Continuous Drain Current vs Case Temperature

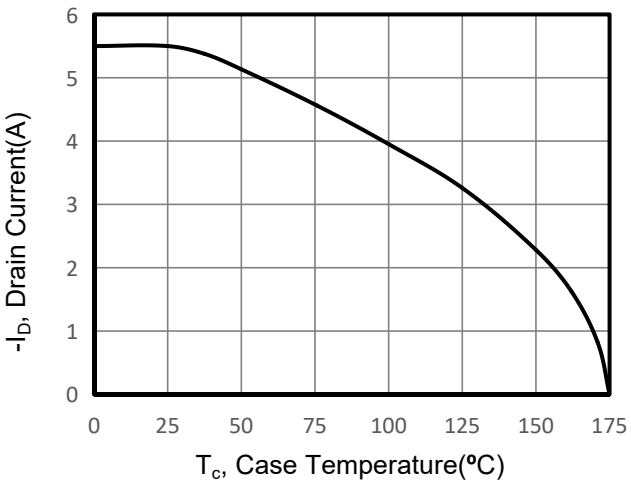
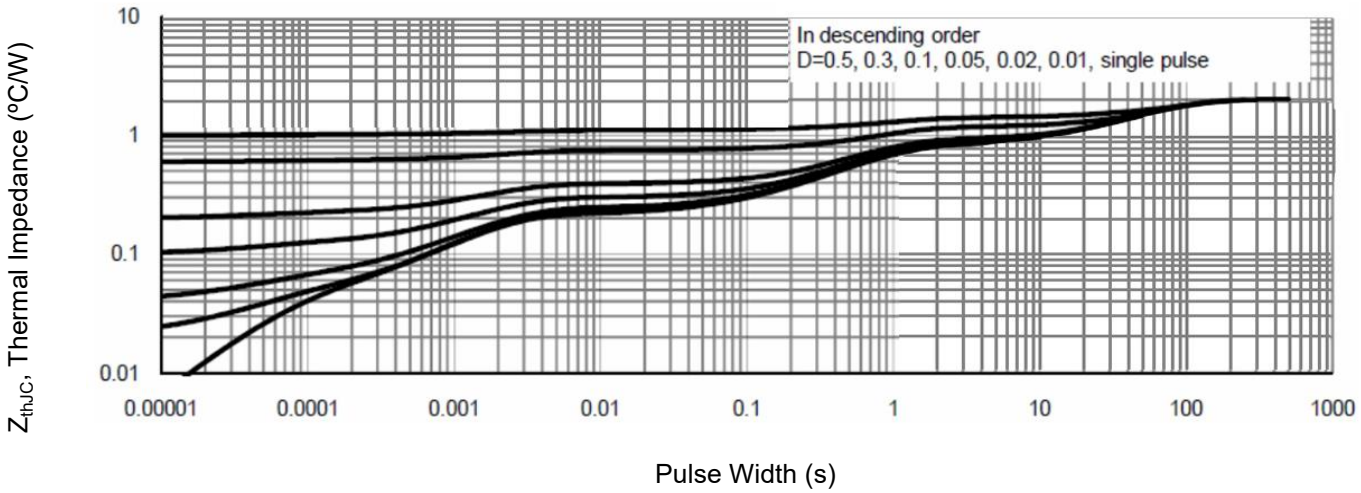
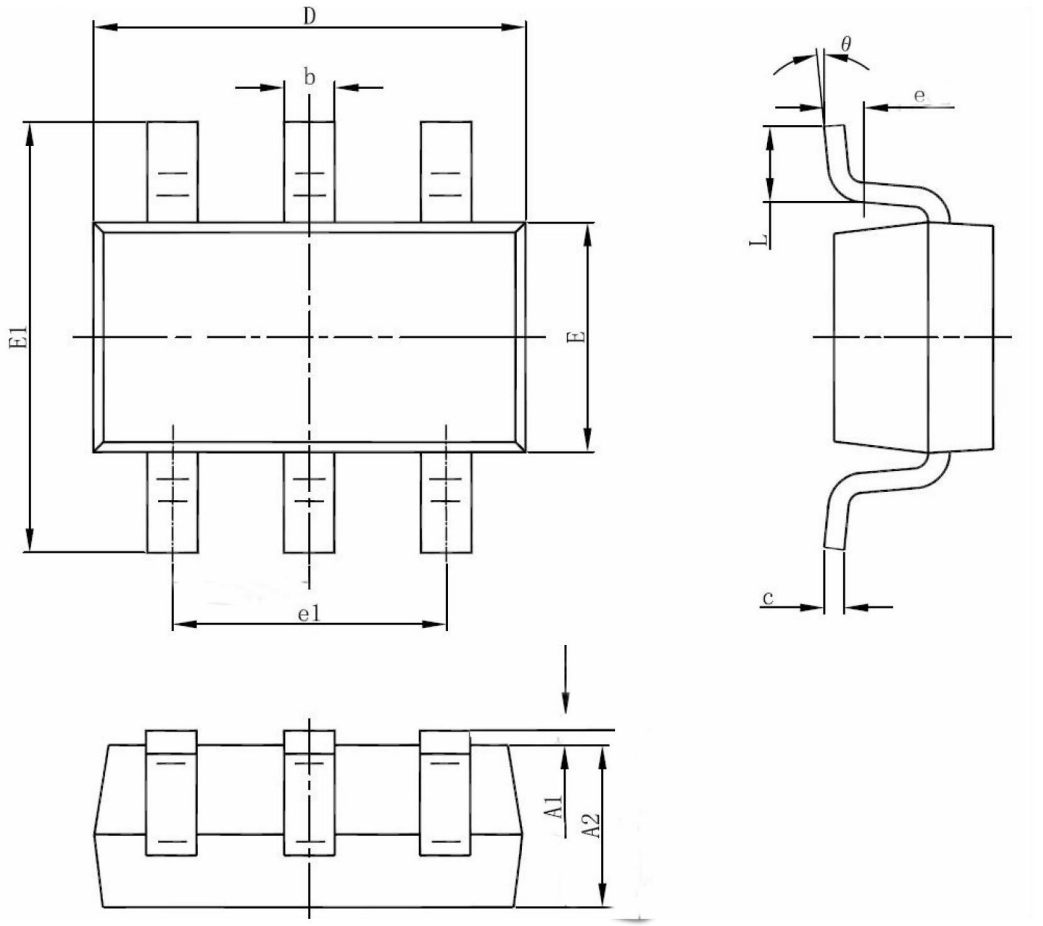


Figure 10. Normalized Maximum Transient Thermal Impedance



SOT-23-6L Package Information



DIM	MIN	NOM	MAX
A1	0.00	-	0.10
A2	1.00	1.10	1.20
b	0.30	0.40	0.50
c	0.10	0.15	0.20
D	2.80	2.90	3.00
E	1.50	1.60	1.70
E1	2.60	2.80	3.00
e	0.2GAUGE PLANE		
e1	-	1.90	-
L	0.30	0.45	0.60
θ	0°	-	8°
All Dimensions in mm			